DSC7004

Silicon NPN epitaxial planar type

For low frequency output amplification Complementary to DSA7004 DSC8004 in MiniP3 type package

Features

- \bullet Low collector-emitter saturation voltage $V_{\mbox{CE(sat)}}$
- Contributes to miniaturization of sets, reduction of component count.
- Eco-friendly Halogen-free package

Packaging

DSC7004×0L Embossed type (Thermo-compression sealing): 1000 pcs / reel (standard)

Absolute Maximum Ratings $T_a = 25^{\circ}C$

Parameter	Symbol	Rating	Unit
Collector-base voltage (Emitter open)	V _{CBO}	60	V
Collector-emitter voltage (Base open)	V _{CEO}	50	V
Emitter-base voltage (Collector open)	V _{EBO}	5	V
Collector current	I _C	2	А
Peak collector current	I _{CP}	3	А
Collector power dissipation	P _C	1	W
Junction temperature	Tj	150	°C
Storage temperature	T _{stg}	-55 to +150	°C

Package

- Code
- MiniP3-F2-B
 - Package dimension clicks here. \rightarrow
- Pin Name
 - 1. Base
 - 2. Collector
 - 3. Emitter

Marking Symbol: 5B

Note) Printed circuit board: Copper foil area of 1 \mbox{cm}^2 or more, and the board thickness
of 1.7 mm for the collector portion

Absolute maximum rating without heat sink for $P_{C}\xspace$ is $\ensuremath{0.5\xspace}\xspace$ W

Electrical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Collector-base voltage (Emitter open)	V _{CBO}	$I_{\rm C} = 10 \ \mu {\rm A}, I_{\rm E} = 0$	60			V
Collector-emitter voltage (Base open)	V _{CEO}	$I_{\rm C} = 1 \text{ mA}, I_{\rm B} = 0$	50			V
Emitter-base voltage (Collector open)	V _{EBO}	$I_{\rm E} = 10 \ \mu A, I_{\rm C} = 0$	5			V
Collector-base cutoff current (Emitter open)	I _{CBO}	$V_{CB} = 20 \text{ V}, I_E = 0$			0.1	μΑ
Forward current transfer ratio *1	h _{FE1} *2	$V_{CE} = 2 \text{ V}, I_C = 200 \text{ mA}$	120		340	
	h _{FE2}	$V_{CE} = 2 V, I_C = 1 A$	80			
Collector-emitter saturation voltage *1	V _{CE(sat)}	$I_{\rm C} = 1 \text{A}, I_{\rm B} = 50 \text{mA}$		0.15	0.3	V
Base-emitter saturation voltage *1	V _{BE(sat)}	$I_{\rm C} = 1 \text{A}, I_{\rm B} = 50 \text{mA}$		0.9	1.2	V
Transition frequency	f_{T}	$V_{CE} = 10 \text{ V}, I_C = 50 \text{ mA}$		120		MHz
Collector output capacitance (Common base, input open circuited)	C _{ob}	$V_{CB} = 10 \text{ V}, I_E = 0, f = 1 \text{ MHz}$		22	35	pF

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

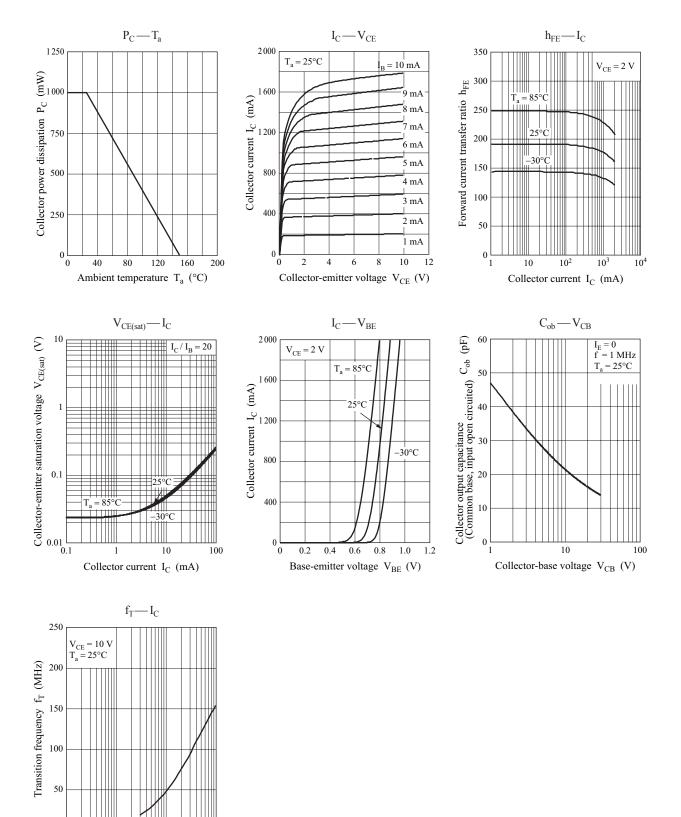
2. *1: Pulse measurement

*2: Rank classification

Code	R	S	0		
Rank	R	S	No-rank		
h_{FE1}	120 to 240	170 to 340	120 to 340		
Marking Symbol	5BR	5BS	5B		
Product of no-rank is not classified and have no marking symbol for rank.					

DSC7004

Panasonic



Ver. DED

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Collector current I_C (mA)

0 0.1

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